

IRFR310TRLPBF Datasheet

www.digi-electronics.com

M



DiGi Electronics Part Number	IRFR310TRLPBF-DG
Manufacturer	Vishay Siliconix
Ianufacturer Product Number	IRFR310TRLPBF
Description	MOSFET N-CH 400V 1.7A DPAK
Detailed Description	N-Channel 400 V 1.7A (Tc) 2.5W (Ta), 25W (Tc) Surf ace Mount DPAK

https://www.DiGi-Electronics.com



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
IRFR310TRLPBF	Vishay Siliconix
Series:	Product Status:
	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
400 V	1.7А (Тс)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	3.60hm @ 1A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
4V @ 250µA	12 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	170 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	2.5W (Ta), 25W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
DPAK	TO-252-3, DPAK (2 Leads + Tab), SC-63
Base Product Number:	
IRFR310	

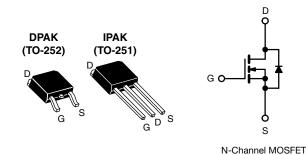
Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
ECCN:	HTSUS:
EAR99	8541.29.0095



Vishay Siliconix

Power MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	400					
R _{DS(on)} (Ω)	V _{GS} = 10 V 3.6					
Q _g max. (nC)	12					
Q _{gs} (nC)	1.9					
Q _{gd} (nC)	6.5					
Configuration	Sin	gle				

- **FEATURES** Dynamic dV/dt rating
- Repetitive avalanche rated
- Surface-mount (IRFR310, SiHFR310) Straight lead (IRFU310, SiHFU310)
- Available in tape and reel
- Fast switching
- Fully avalanche rated
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs form Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface-mount applications.

ORDERING INFORMATION							
Package DPAK (TO-252) DPAK (TO-252) DPAK (TO-252) IPAK (TO-251)							
Lood (Db) free and belogen free	SiHFR310-GE3	SiHFR310TRL-GE3 a	SiHFR310TR-GE3 ^a	SiHFU310-GE3			
Lead (Pb)-free and halogen-free	SiHFR310TRR-GE3 ^a	IRFR310TRLPbF-BE3 ^{a, b}	IRFR310TRPbF-BE3 ^{a, b}	-			
Lead (Pb)-free	IRFR310PbF	IRFR310TRLPbF ^a	IRFR310TRPbF ^a	IRFU310PbF			

Notes

a. See device orientation

b. "-BE3" denotes alternate manufacturing location

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	400	V
Gate-source voltage			V _{GS}	± 20	- V
Continuous drain current V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$			1	1.7	
Continuous drain current	ID	1.1	А		
Pulsed drain current ^a	I _{DM}	6.0			
Linear derating factor				0.20	W/°C
Linear derating factor (PCB mount) ^e		0.020	- W/ C		
Single pulse avalanche energy ^b			E _{AS}	86	mJ
Repetitive avalanche current ^a			I _{AR}	1.7	А
Repetitive avalanche energy ^a			E _{AR}	2.5	mJ
Maximum power dissipation	25 °C	D	25	w	
Maximum power dissipation (PCB mount) e T _A = 25 $^{\circ}$ C			PD	2.5	vv
Peak diode recovery dV/dt ^c			dV/dt	4.0	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	- °C
Soldering recommendations (peak temperature) d	For	10 s		260	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 52 mH, $R_g = 25 \Omega$, $I_{AS} = 1.7$ A (see fig. 12)

c. $I_{SD} \leq 1.7$ A, dl/dt ≤ 40 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C

d. 1.6 mm from case

e. When mounted on 1" square PCB (FR-4 or G-10 material)

S23-0902-Rev. F, 30-Oct-2023

1

Document Number: 91272

COMPLIANT

HALOGEN

FREE



Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient (PCB mounted, steady-state) ^a	R _{thJA}	-	50			
Maximum junction-to-ambient	R _{thJA}	-	110	°C/W		
Maximum junction-to-case	R _{thJC}	-	5.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	400	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.47	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 20 V$	-	-	± 100	nA
Zana ante contra dusia sumant	1	V _{DS} =	= 400 V, V _{GS} = 0 V	-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 320 \	∕, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.0 A ^b	-	-	3.6	Ω
Forward transconductance	9 _{fs}	V _{DS} =	50 V, I _D = 1.0 A ^b	0.97	-	-	S
Dynamic		•		•	•	•	
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	170	-	
Output capacitance	C _{oss}		$V_{DS} = 25 V$, f = 1.0 MHz, see fig. 5 °		34	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.			6.3	-	
Total gate charge	Qg			-	-	12	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 2.0 A, V _{DS} = 320 V, see fig. 6 and 13 ^{b, c}	-	-	1.9	nC
Gate-drain charge	Q _{gd}		see lig. 0 and 10	-	-	6.5	
Turn-on delay time	t _{d(on)}				7.9	-	-
Rise time	t _r	$V_{DD} = 200 \text{ V}, \text{ I}_{D} = 2.0 \text{ A},$		-	9.9	-	
Turn-off delay time	t _{d(off)}	$ R_g =$	24 Ω, R _D = 95 Ω, see fig. 10 ^{b, c}	-	21	-	- ns
Fall time	t _f		5	-	11	-	
Gate input resistance	R _g	f = 1	MHz, open drain	1.7	-	11.2	Ω
Internal drain inductance	L _D	6 mm (0.25	Between lead, 6 mm (0.25") from		4.5	-	
Internal source inductance	L _S	package and die cont		-	7.5	-	nH
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	١ _S	MOSFET sym showing the	bol	-	-	1.7	А
Pulsed diode forward current ^a	I _{SM}	integral revers p - n junction		-	-	6.0	
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 1.7 A, V _{GS} = 0 V ^b	-	-	1.6	V
Body diode reverse recovery time	t _{rr}	T 25 °C I	= 2.0 A, dl/dt = 100 A/µs ^b	-	240	540	ns
Body diode reverse recovery charge	Q _{rr}	$I_{\rm J} = 25$ 0, I _F	-2.0 Å, $u/u_1 = 100$ Å/ μ S °	-	0.85	1.6	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Pulse width \leq 300 µs; duty cycle \leq 2 %



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

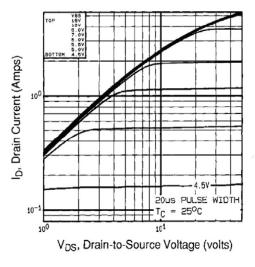


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

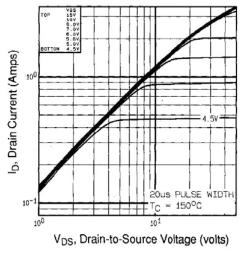


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

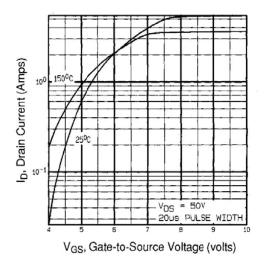


Fig. 3 - Typical Transfer Characteristics

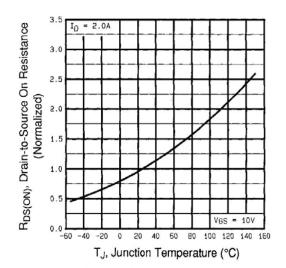


Fig. 4 - Normalized On-Resistance vs. Temperature



Vishay Siliconix

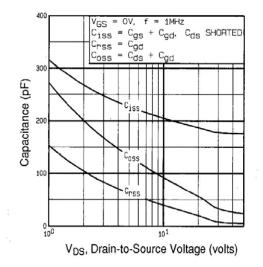


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

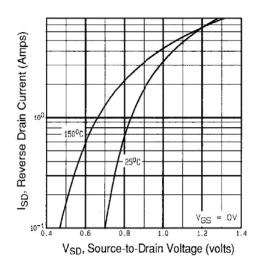


Fig. 7 - Typical Source-Drain Diode Forward Voltage

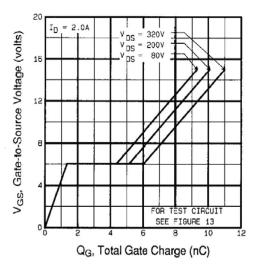


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

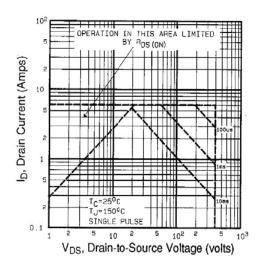


Fig. 8 - Maximum Safe Operating Area



Vishay Siliconix

www.vishay.com

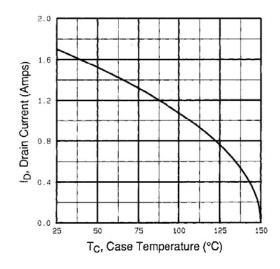


Fig. 9 - Maximum Drain Current vs. Case Temperature

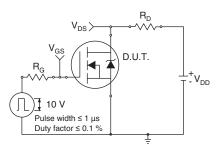


Fig. 10a - Switching Time Test Circuit

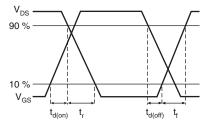


Fig. 10b - Switching Time Waveforms

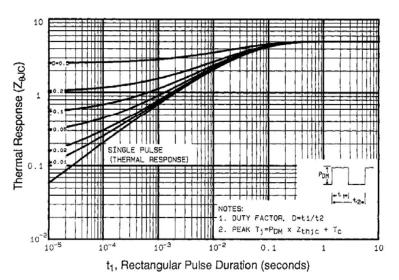


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

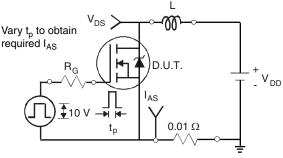


Fig. 12a - Unclamped Inductive Test Circuit

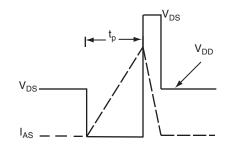


Fig. 12b - Unclamped Inductive Waveforms

S23-0902-Rev. F, 30-Oct-2023

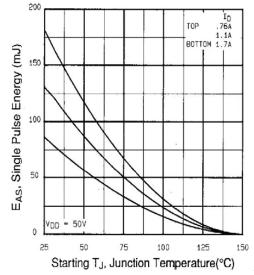
5

Document Number: 91272

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix





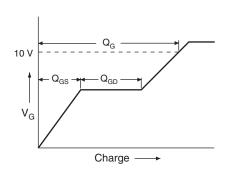


Fig. 13a - Basic Gate Charge Waveform

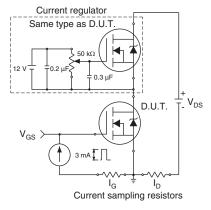
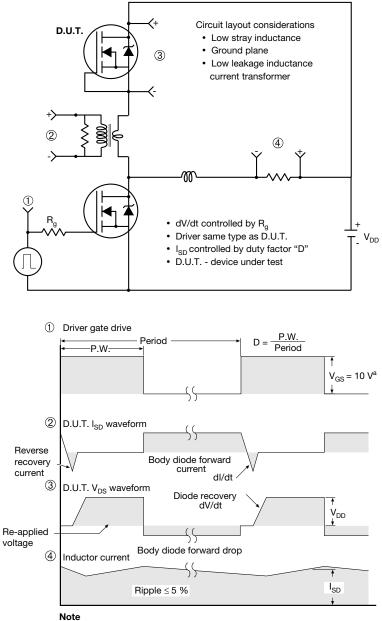


Fig. 13b - Gate Charge Test Circuit



Vishay Siliconix

Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91272.

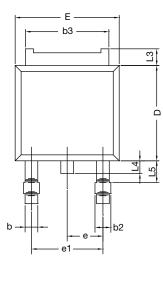


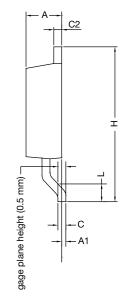
Package Information

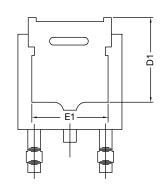
Vishay Siliconix

TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	BSC		
e1	4.56	BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only

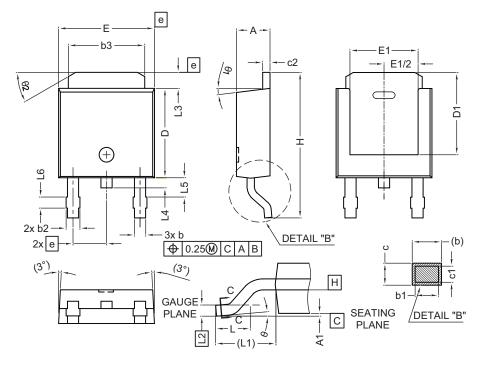


www.vishay.com

Package Information

Vishay Siliconix

VERSION 2: FACILITY CODE = N



	MILLIMETERS				
DIM.	MIN.	MAX.			
А	2.18	2.39			
A1	-	0.13			
b	0.65	0.89			
b1	0.64	0.79			
b2	0.76	1.13			
b3	4.95	5.46			
с	0.46	0.61			
c1	0.41	0.56			
c2	0.46	0.60			
D	5.97	6.22			
D1	5.21	-			
E	6.35	6.73			
E1	4.32	-			
e	2.29	BSC			
Н	9.94	10.34			

	MILLIMETERS				
DIM.	MIN.	MAX.			
L	1.50	1.78			
L1	2.74	ref.			
L2	0.51 BSC				
L3	0.89	1.27			
L4	-	1.02			
L5	1.14	1.49			
L6	0.65	0.85			
θ	0°	10°			
θ1	0°	15°			
θ2	25°	35°			

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347



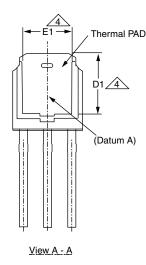
www.vishay.com

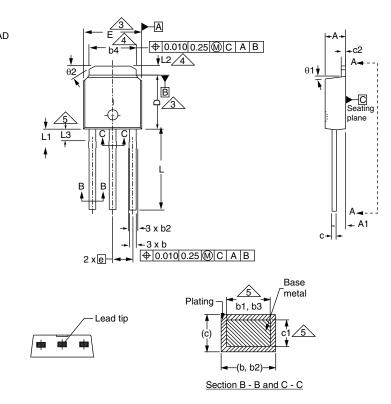
Package Information

Vishay Siliconix

Case Outline for TO-251AA (High Voltage)

OPTION 1:





	MILLIMETERS		INCHES				MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DI	٨.	MIN.	MAX.	MIN.	MAX
А	2.18	2.39	0.086	0.094	D		5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E		6.35	6.73	0.250	0.265
b	0.64	0.89	0.025	0.035	E		4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е		2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L		8.89	9.65	0.350	0.380
b3	0.76	1.04	0.030	0.041	L1		1.91	2.29	0.075	0.090
b4	4.95	5.46	0.195	0.215	L2	2	0.89	1.27	0.035	0.050
С	0.46	0.61	0.018	0.024	L3	3	1.14	1.52	0.045	0.060
c1	0.41	0.56	0.016	0.022	θ1		0'	15'	0'	15'
c2	0.46	0.86	0.018	0.034	θ2	2	25'	35'	25'	35'
D	5.97	6.22	0.235	0.245				•	•	•

DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA

Revision: 27-Dec-2021

1

Document Number: 91362

For technical questions, contact: <u>hvmos.techsupport@vishay.com</u>

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

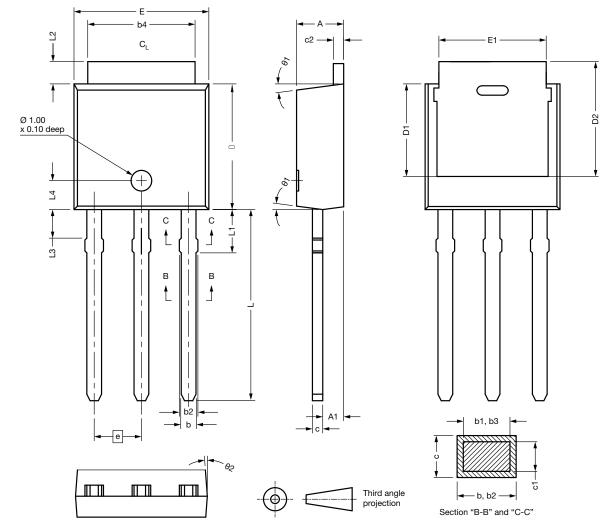


www.vishay.com

Package Information

Vishay Siliconix

OPTION 2: FACILITY CODE = N



DIM.	MIN.	NOM.	MAX.		DIM.	MIN.	NOM.	MAX.
А	2.180	2.285	2.390		D2	5.380	-	-
A1	0.890	1.015	1.140		E	6.350	6.540	6.730
b	0.640	0.765	0.890	1 [E1	4.32	-	-
b1	0.640	0.715	0.790	1 [е	2.29 BSC		
b2	0.760	0.950	1.140	1 [L	8.890	9.270	9.650
b3	0.760	0.900	1.040	1 [L1	1.910	2.100	2.290
b4	4.950	5.205	5.460	1 [L2	0.890	1.080	1.270
С	0.460	-	0.610	1 [L3	1.140	1.330	1.520
c1	0.410	-	0.560	1 [L4	1.300	1.400	1.500
c2	0.460	-	0.610	1 [θ1	0°	7.5°	15°
D	5.970	6.095	6.220	1 [θ2	4°	-	-
D1	4.300	-	-	1 F		•	•	•

Notes

Dimensioning and tolerancing per ASME Y14.5M-1994

• All dimension are in millimeters, angles are in degrees

• Heat sink side flash is max. 0.8 mm

Revision: 27-Dec-2021

2

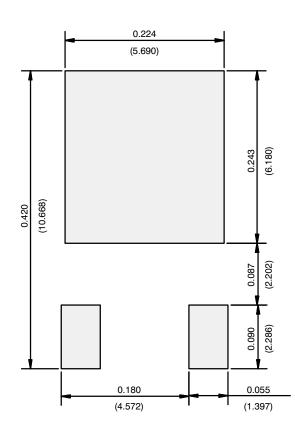
Document Number: 91362



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2025 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jan-2025



OUR CERTIFICATE

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

	<section-header></section-header>		
Marginary Marginary Marginary	Market	Marchine Marchine Image: Control of the sector of the sec	





Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.